

# LNG91LCFB

## Round Type

φ5.0 mm

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power dissipation	$P_D$	120	mW
Forward current	$I_F$	30	mA
Pulse forward current *	$I_{FP}$	100	mA
Reverse voltage	$V_R$	5	V
Operating ambient temperature	$T_{opr}$	-25 to +80	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-30 to +100	$^\circ\text{C}$

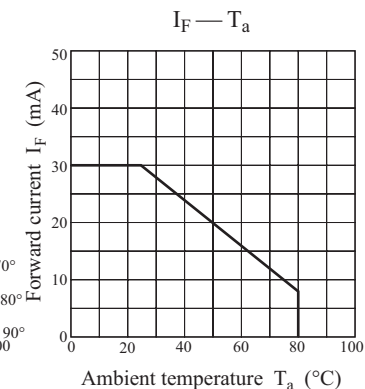
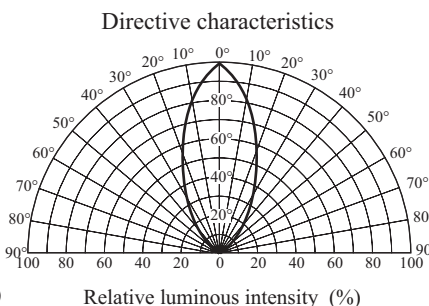
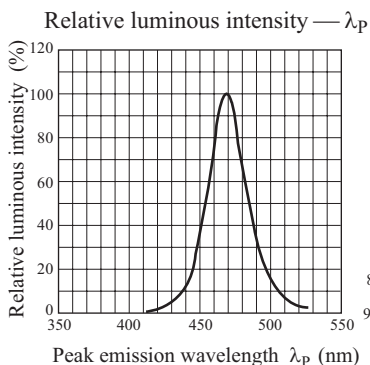
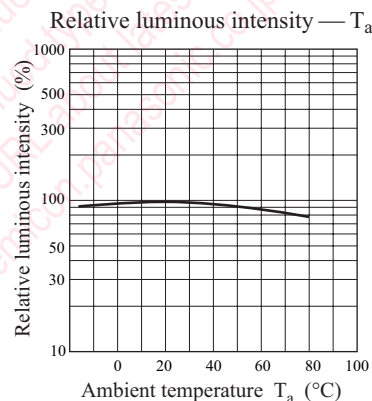
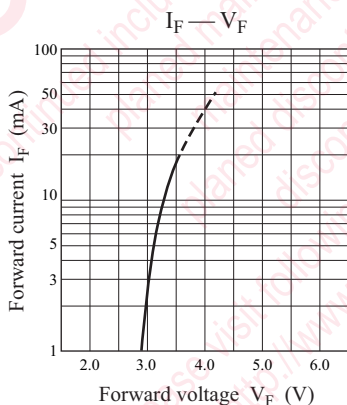
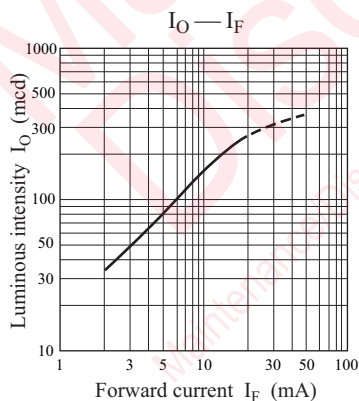
### ■ Lighting Color

- Blue

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 10 msec.

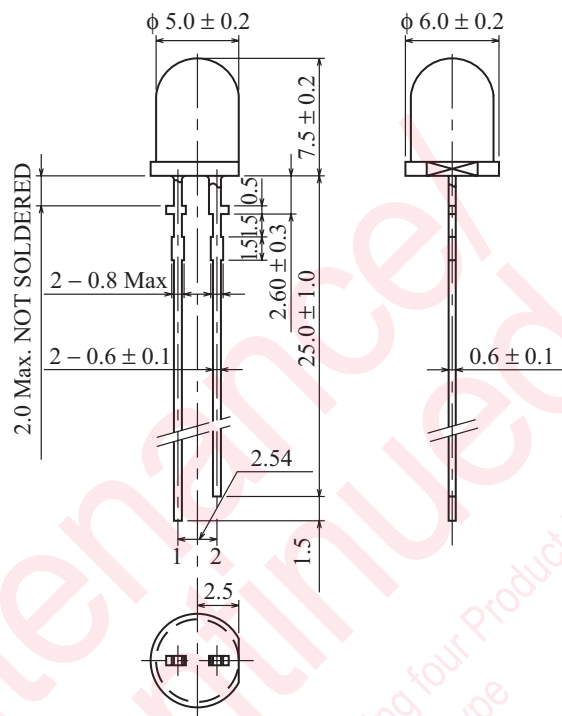
### ■ Electro-Optical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity	$I_O$	$I_F = 20\text{ mA}$	210	350		mcd
Reverse current	$I_R$	$V_R = 5\text{ V}$			10	$\mu\text{A}$
Forward voltage	$V_F$	$I_F = 20\text{ mA}$		3.5	4.0	V
Peak emission wavelength	$\lambda_p$	$I_F = 20\text{ mA}$		468		nm
Spectral half band width	$\Delta\lambda$	$I_F = 20\text{ mA}$		30		nm



■ Package (Unit: mm)

### LLXLTN2SF1L0



- Pin name
- 1: Anode
- 2: Cathode

Maintenance/Discontinued includes following four Product lifecycle stage.  
planned maintenance type  
maintenance type  
planned discontinued typed  
discontinued type  
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